



MGFS6 series Reliability test results

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OS DESIGN DEPT.

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No.	Test Item	Testing conditions	Conditions of acceptability	Number of samples	Number of failures
1	Heat cycle test	(1) -40° C ~ 125° C 30minutes each (2) 800cycles	(1)No degradation of electric characteristics after test. (2)No crack at solder joint.	5	0
2	High temperature/ High humidity bias test	(1) Ta=85°C, RH=85% (2) Input Max.Voltege (3) Load 0% (4) 1000hours	(1)No degradation of electric characteristics after test.	5	0
3	Vibration test	(1) f=10~55Hz, 98.0m/s <sup>2</sup> (10G) (2) 3minutes period (3) 60minutes each X, Y and Z axis	(1)No degradation of electric characteristics after test. (2)No crack at solder joint. (3)No mechanical damage of appearance.	6	0
4	Impact test	(1) 490.3m/s <sup>2</sup> (50G), 11ms (2) Once each X, Y and Z axis	(1)No degradation of electric characteristics after test. (2)No crack at solder joint. (3)No thermal damage of appearance.	3	0
5	Soldering heat test	(1) Soldering iron 340~360°C, 7.5 seconds (2) Mounting board : t=1.6mm / FR4	(1)No crack at solder joint. (2)No marked damage of appearance.	1	0
6	Pin solder ability test	(1) Pre-process Step1 Humidifying processing (100°C, 100%, 1H) Step2 Dip into flux (2) Dip soldering 230~240°C, 2sec	(1)Over 95% of dipped part is covered with solder.	3	0
7	Pin strength test	(1) Weight : 1kg (2) Bending angle : 90 deg., total 180 deg. (3) 1 cycle	(1)No crack at solder joint. (2)No mechanical damage of appearance.	1	0
8	Static electricity immunity test	(1) Applied voltage ±4kV (2) At rated input and load (3) Testing circuitry Fig.1	(1)No protection circuit fail. (2)No output voltage drop due to control (3)No any other function fail.	1	0



○Testing circuitry

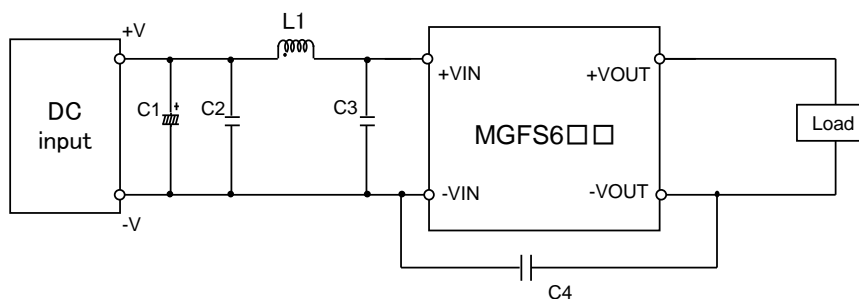


Fig.1 Testing circuitry

- |      |                        |   |
|------|------------------------|---|
| C1 : | MGFS624□□<br>MGFS648□□ | 50V 100 $\mu$ F Electric capacitor (LXZseries NIPPON CHEMI-CON)<br>-  |
| C2 : | MGFS624□□<br>MGFS648□□ | 50V 4.7 $\mu$ F Ceramic capacitor (GRM31CR71H475K MURATA MANUFACTURING)<br>100V 2.2 $\mu$ F Ceramic capacitor (GRM31CC72A225K MURATA MANUFACTURING) |
| C3 : | MGFS624□□<br>MGFS648□□ | 50V 4.7 $\mu$ F Ceramic capacitor (GRM31CR71H475K MURATA MANUFACTURING)<br>100V 2.2 $\mu$ F Ceramic capacitor (GRM31CC72A225K MURATA MANUFACTURING) |
| C4 : | MGFS624□□<br>MGFS648□□ | 2kV 470pF Ceramic capacitor (GR442QR73D471K MURATA MANUFACTURING)<br>2kV 2200pF Ceramic capacitor (GR443QR73D222K MURATA MANUFACTURING)             |
| L1 : | MGFS624□□<br>MGFS648□□ | 1600mA 10 $\mu$ H Inductor(LQH5BPN100MT0 MURATA MANUFACTURING)<br>1050mA 22 $\mu$ H Inductor(LQH5BPN220MT0 MURATA MANUFACTURING)                    |